High Speed Infrared Emitting Diodes, 890 nm, Surface Emitter Technology

VSMY2893RGX01

VSMY2893GX01

VSMY2893SLX01

FEATURES

- Package type: surface-mount
- Package form: GW, RGW, side view
- Dimensions (L x W x H in mm): 2.3 x 2.3 x 2.55
- AEC-Q101 qualified
- Peak wavelength: λ_p = 890 nm
- Angle of half intensity: φ = ± 28°
- Suitable for high pulse current operation
- Terminal configurations: gullwing or reverse gullwing
- Package matches with detector VEMD2503X01 series
- Floor life: 4 weeks, MSL 2a, according to J-STD-020
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

AUTOMOTIVE GRADE

Pb-free

e3

RoHS COMPLIANT

HALOGEN FREE

GREEN (5-2008)

DESCRIPTION

As part of the SurfLight™ portfolio, the VSMY2893 series are infrared, 890 nm emitting diodes based on GaAlAs surface emitter chip technology with extreme high radiant intensities, high optical power and high speed, molded in clear, untinted plastic packages (with lens) for surface mounting (SMD).

APPLICATIONS

- Automotive sensors
- Optical switch
- Emitter source for proximity sensors
- IR illumination

PRODUCT SUMMARY				
COMPONENT	I_e (mW/sr) at I_F = 100 mA	φ (°)	λ_P (nm)	t_r (ns)
VSMY2893RGX01	50	± 28	890	15
VSMY2893GX01	50	± 28	890	15
VSMY2893SLX01	50	± 28	890	15

Note

- Test conditions see table “Basic Characteristics“

ORDERING INFORMATION			
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM
VSMY2893RGX01	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Reverse gullwing
VSMY2893GX01	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Gullwing
VSMY2893SLX01	Tape and reel	MOQ: 6000 pcs, 3000 pcs/reel	Side view

Note

- MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)				
PARAMETER	**TEST CONDITION**	**SYMBOL**	**VALUE**	**UNIT**
Forward current		I_F	100	mA
Peak forward current	t_p/T = 0.5, t_p = 100 µs	I_{FM}	200	mA
Surge forward current	t_p = 100 µs	I_{FSM}	1	A
Power dissipation		P_V	190	mW
Junction temperature		T_j	100	°C
Operating temperature range		T_{amb}	-40 to +85	°C
Storage temperature range		T_{stg}	-40 to +100	°C
Soldering temperature	According to Fig. 9, J-STD-020	T_{sd}	260	°C
Thermal resistance junction-to-ambient	JESD51	R_{thJA}	250	K/W

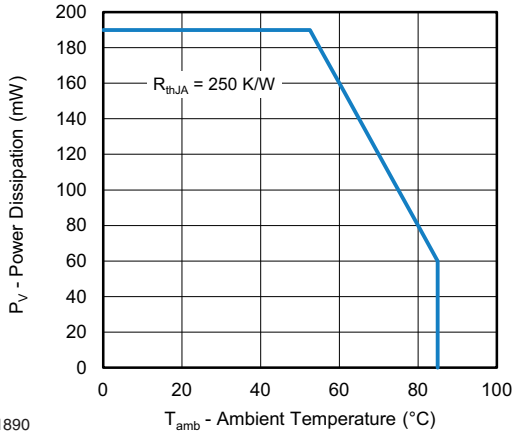


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

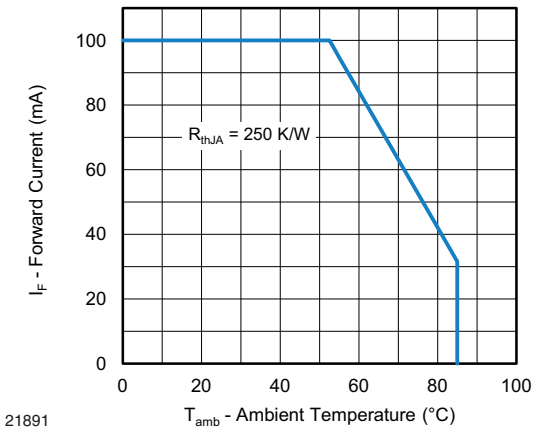


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)						
PARAMETER	**TEST CONDITION**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Forward voltage	I_F = 100 mA, t_p = 20 ms	V_F	-	1.6	1.9	V
	I_F = 1 A, t_p = 100 µs	V_F	-	2.8	-	V
Temperature coefficient of V_F	I_F = 100 mA	TK_{VF}	-	-2.0	-	mV/K
Reverse current		I_R	Not designed for reverse operation			µA
Junction capacitance	V_R = 0 V, f = 1 MHz, E = 0 mW/cm²	C_J	-	60	-	pF
Radiant intensity	I_F = 100 mA, t_p = 20 ms	I_e	27	50	75	mW/sr
	I_F = 1 A, t_p = 100 µs	I_e	-	350	-	mW/sr
Radiant power	I_F = 100 mA, t_p = 20 ms	ϕ_e	-	55	-	mW
Temperature coefficient of radiant power	I_F = 100 mA	$TK\phi_e$	-	-0.15	-	%/K
Angle of half intensity		φ	-	± 28	-	°
Peak wavelength	I_F = 100 mA	λ_p	870	890	910	nm
Spectral bandwidth	I_F = 100 mA	$\Delta\lambda$	-	35	-	nm
Temperature coefficient of λ_p	I_F = 100 mA	$TK\lambda_p$	-	0.3	-	nm/K
Rise time	I_F = 100 mA, 10 % to 90 %	t_r	-	15	-	ns
Fall time	I_F = 100 mA, 10 % to 90 %	t_f	-	15	-	ns

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

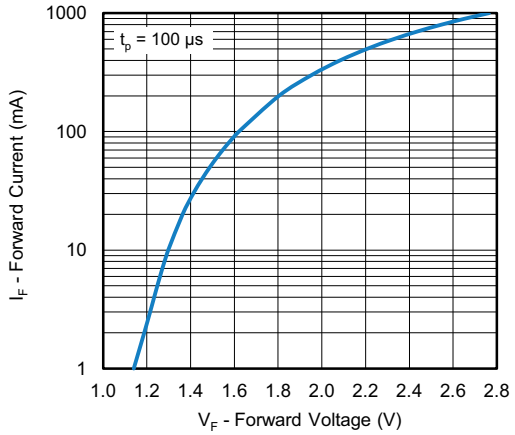


Fig. 3 - Forward Current vs. Forward Voltage

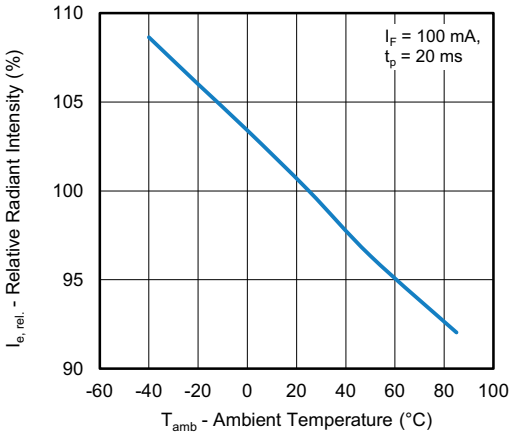


Fig. 6 - Relative Radiant Intensity vs. Ambient Temperature

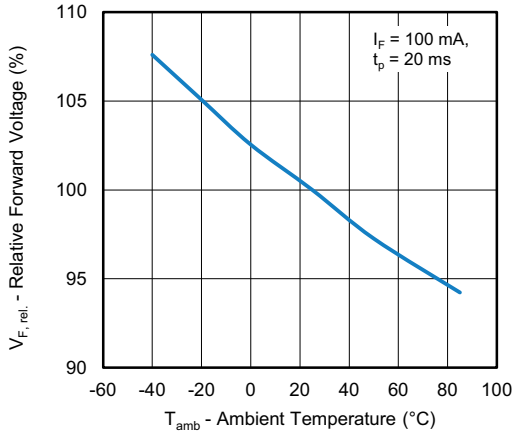


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

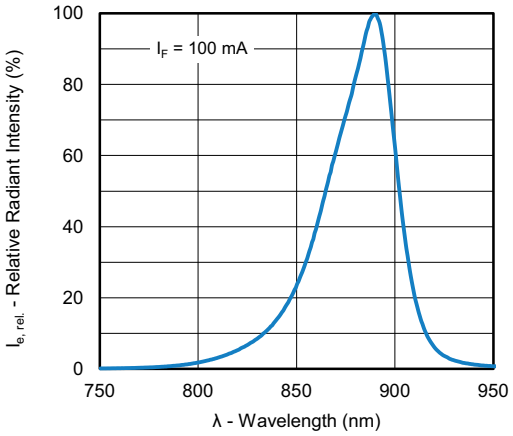


Fig. 7 - Relative Radiant Intensity vs. Wavelength

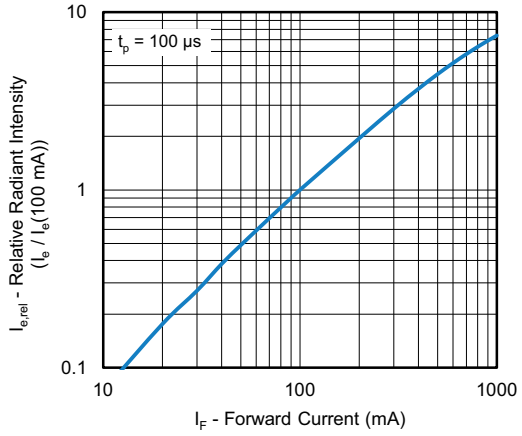


Fig. 5 - Relative Radiant Intensity vs. Forward Current

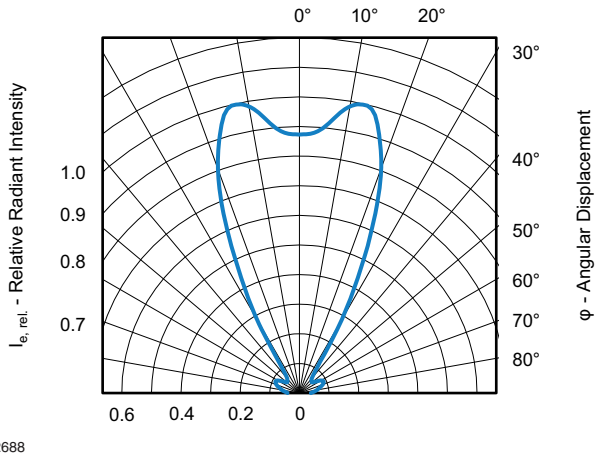


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

SOLDER PROFILE

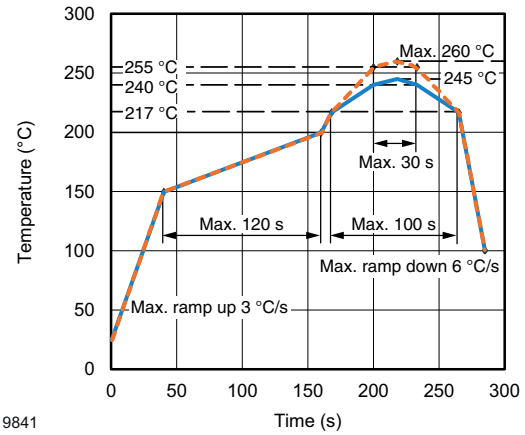


Fig. 9 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 4 weeks

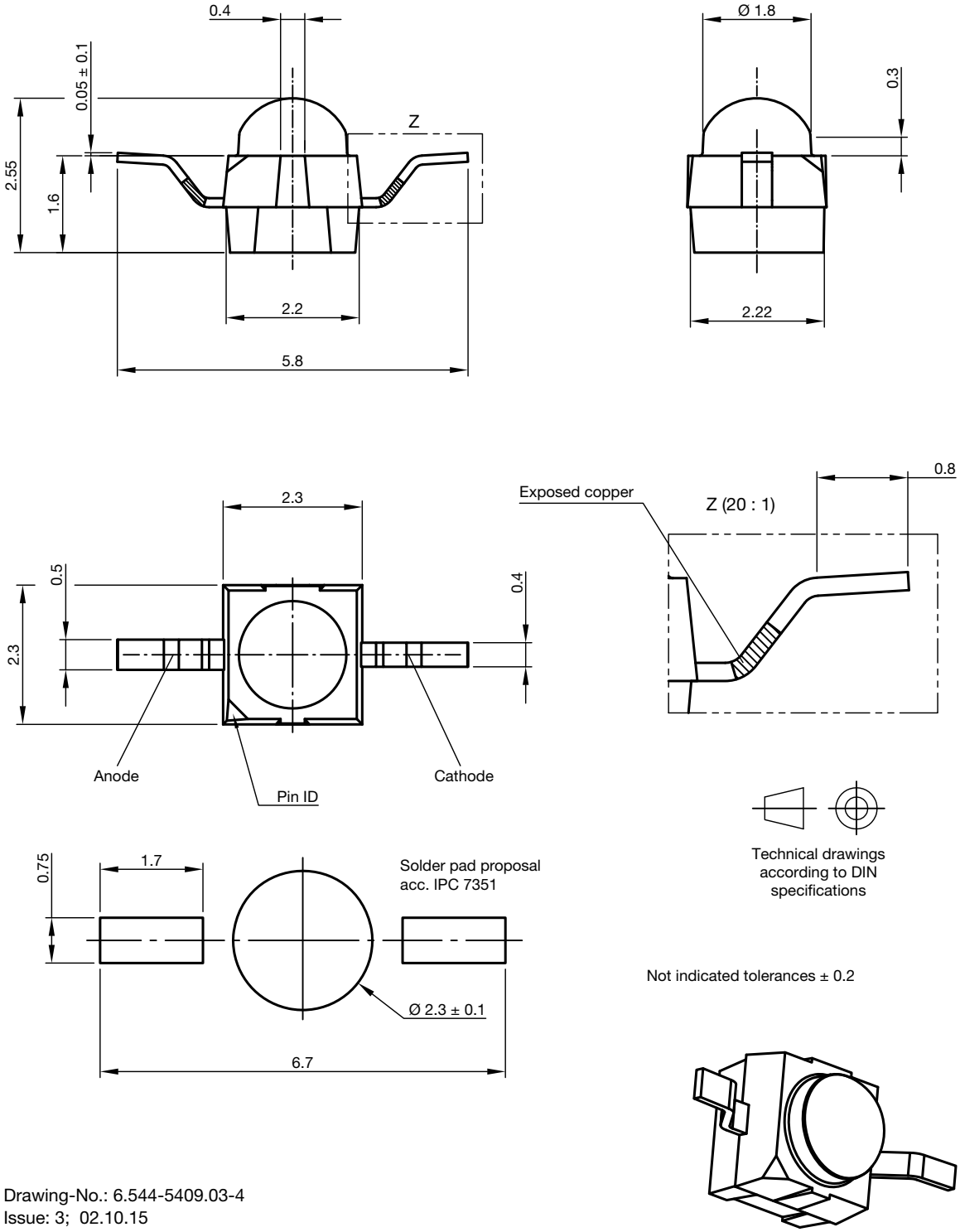
Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 2a, according to J-STD-020.

DRYING

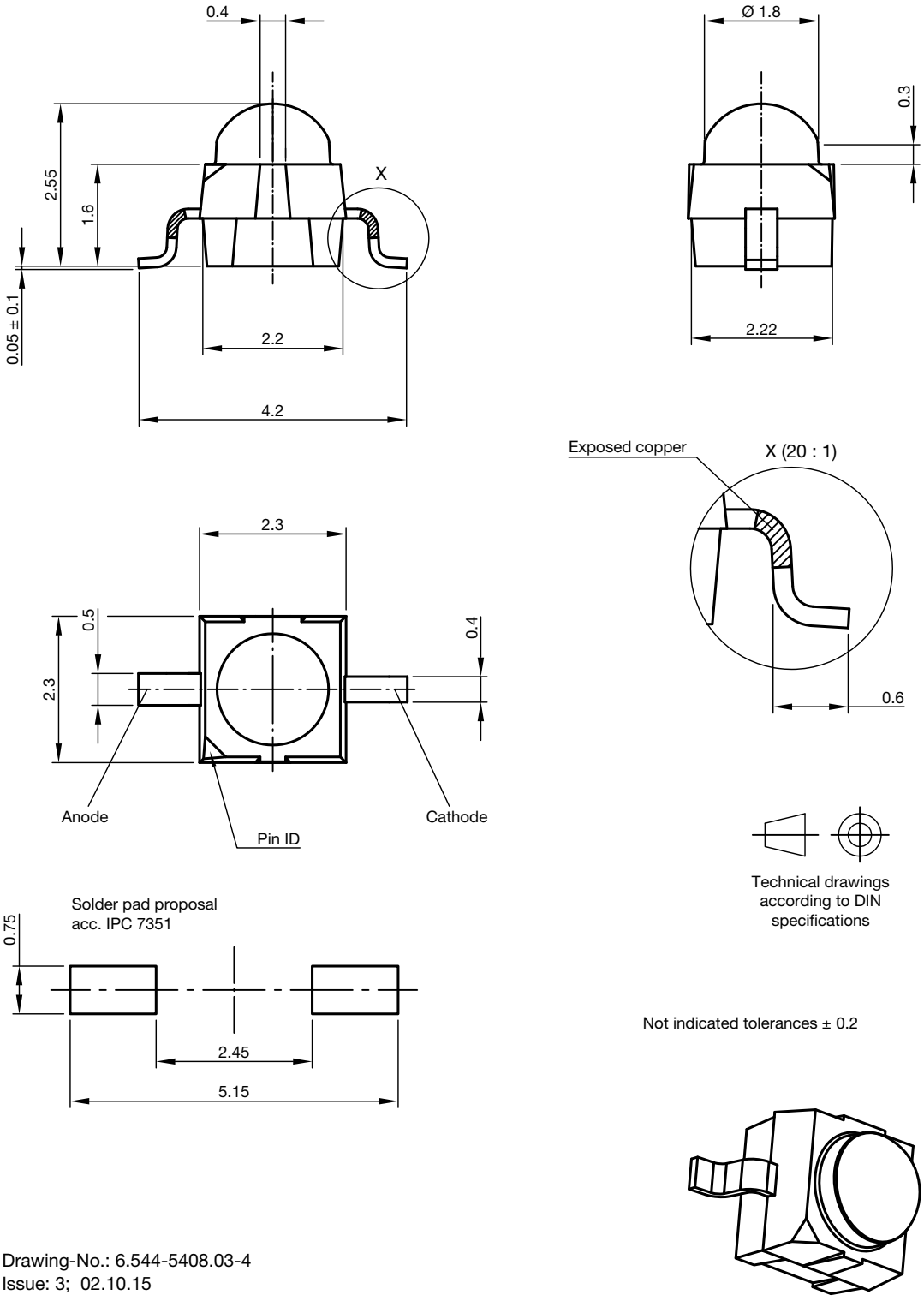
In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-033D or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

PACKAGE DIMENSIONS in millimeters: **VSMY2893RGX01**



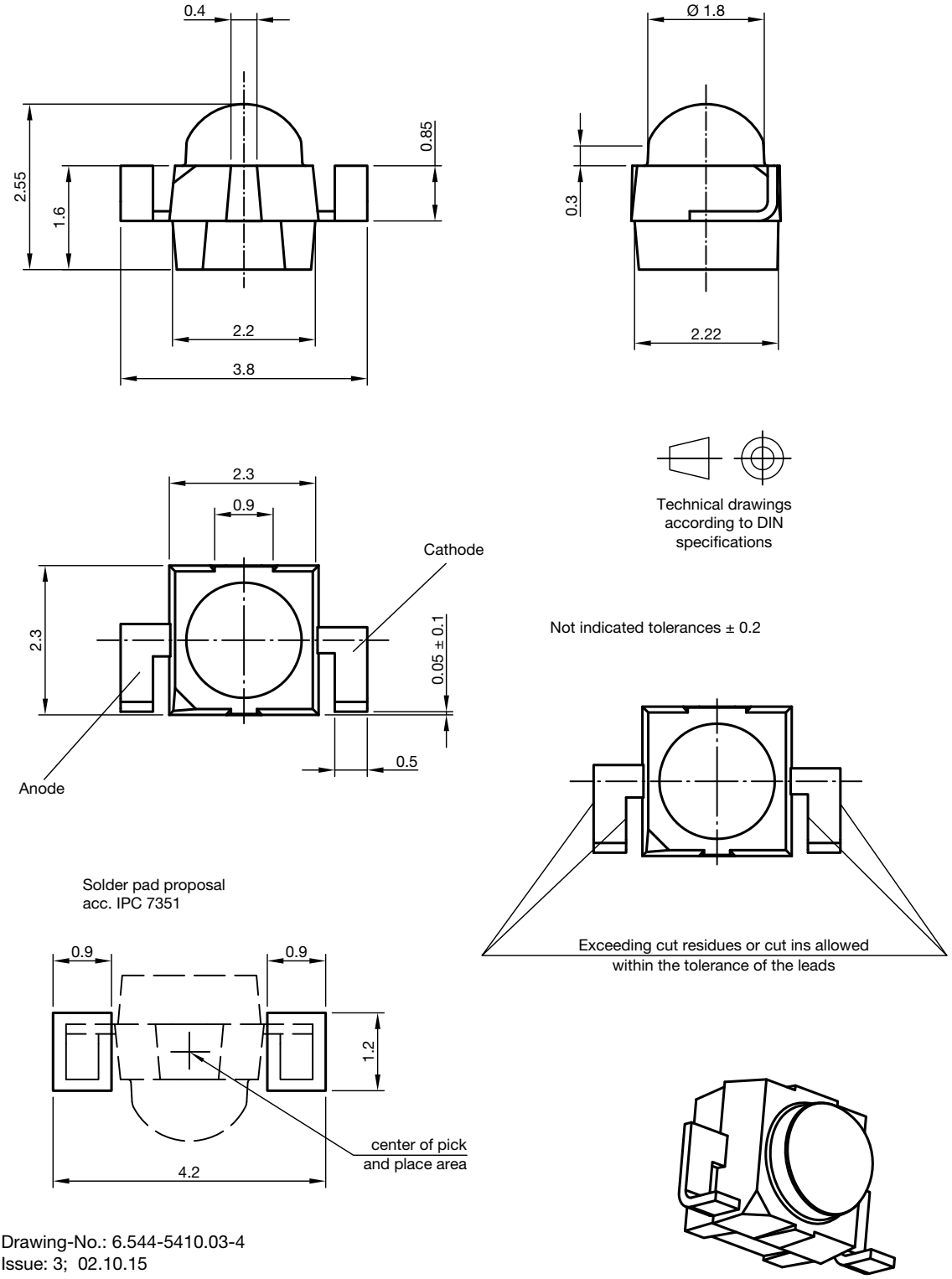
Drawing-No.: 6.544-5409.03-4
Issue: 3; 02.10.15

PACKAGE DIMENSIONS in millimeters: **VSMY2893GX01**



Drawing-No.: 6.544-5408.03-4
Issue: 3; 02.10.15

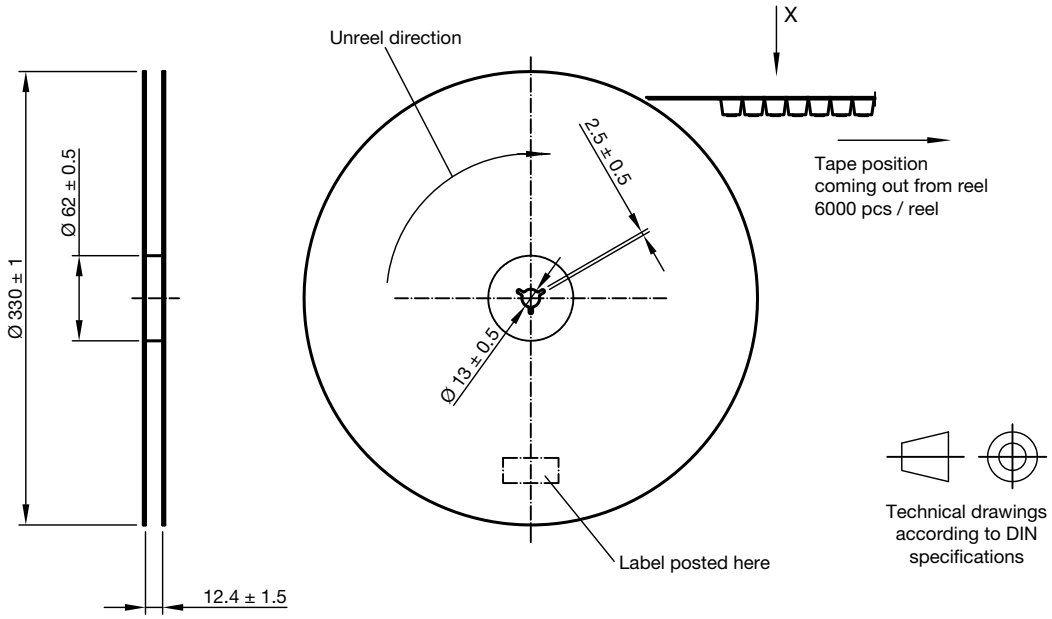
PACKAGE DIMENSIONS in millimeters: **VSMY2893SLX01**



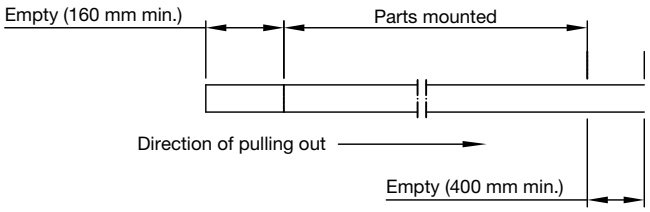
Drawing-No.: 6.544-5410.03-4
Issue: 3; 02.10.15

TAPING AND REEL DIMENSIONS in millimeters: **VSMY2893RGX01**

Reel

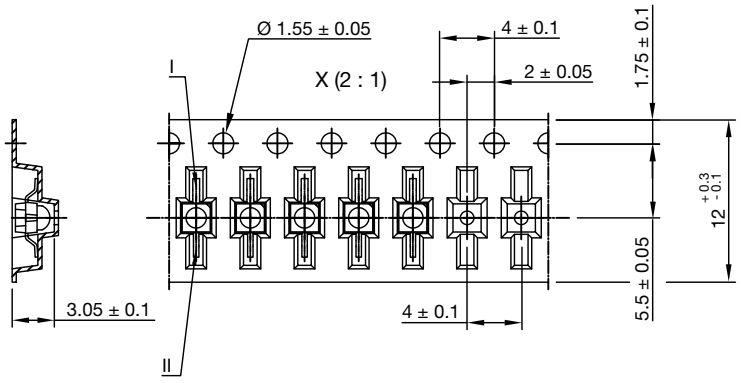


Leader and trailer tape



Terminal position in tape

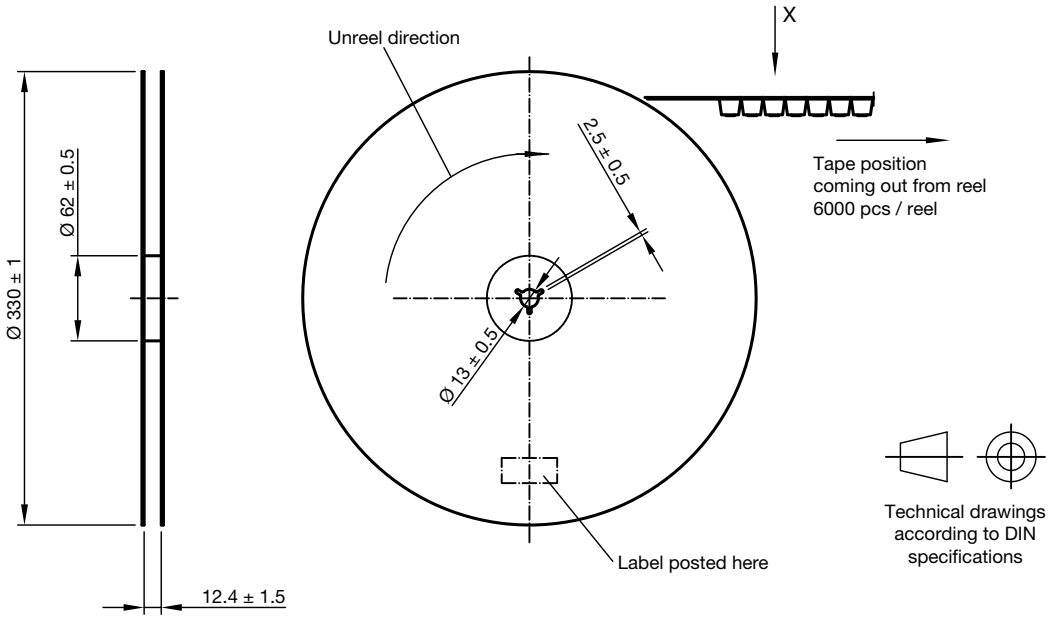
Device	Lead I	Lead II
VSMB2943RGX01	Cathode	Anode
VSMF2893RGX01		
VEMD2x03X01		
VEMT2x03X01	Collector	Emitter
VSMY2xxx	Anode	Cathode



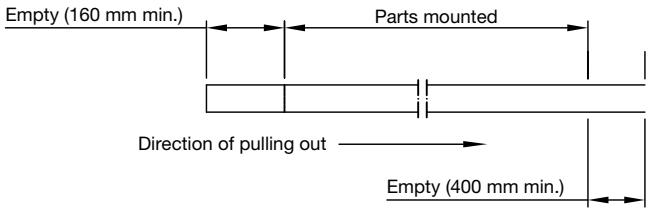
Drawing-No.: 9.800-5100.02-4
Issue: prel.; 11.07.19

TAPING AND REEL DIMENSIONS in millimeters: **VSMY2893GX01**

Reel

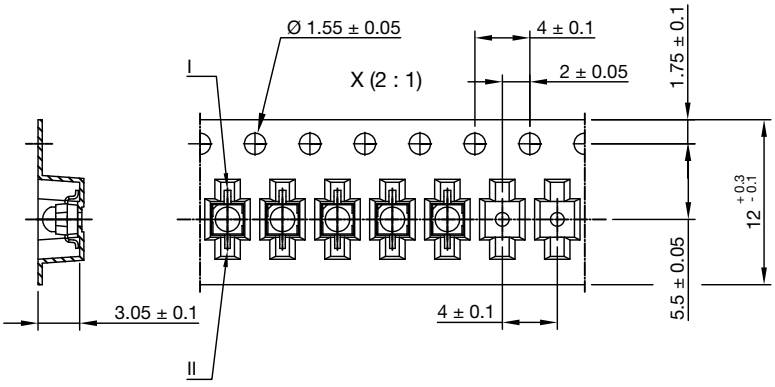


Leader and trailer tape



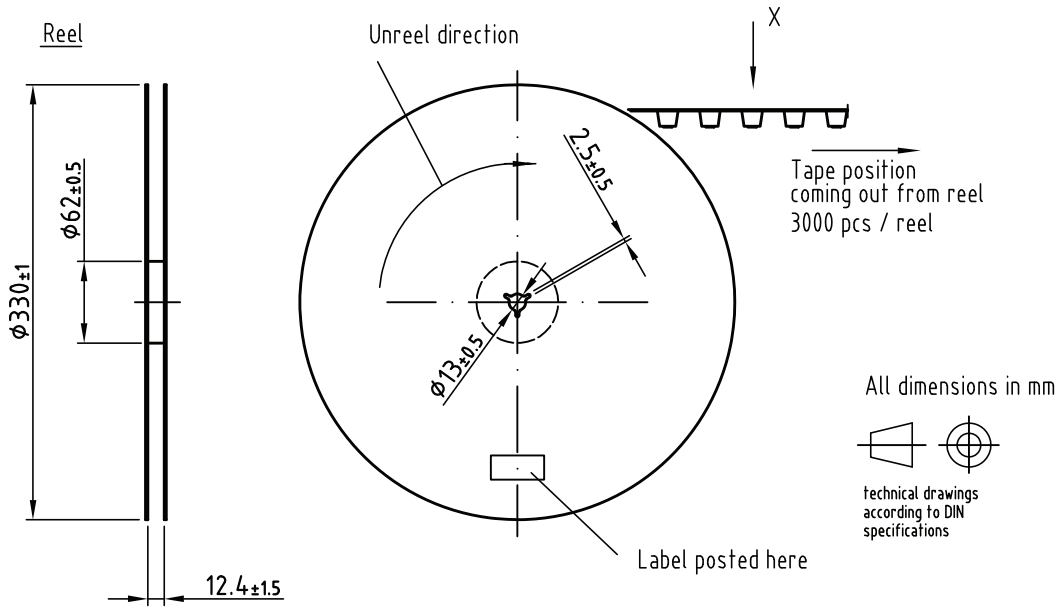
Terminal position in tape

Device	Lead I	Lead II
VSMB2943GX01	Cathode	Anode
VSMF2893GX01		
VEMD2x23X01		
VEMT2x23X01	Collector	Emitter
VSMY2xxx	Anode	Cathode

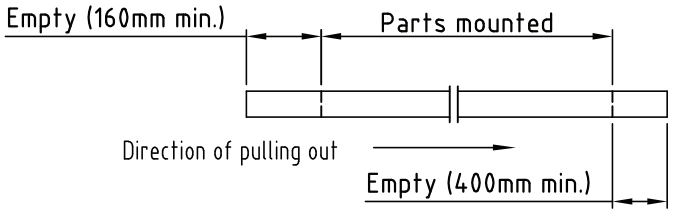


Drawing-No.: 9.800-5091.21-4
Issue: prel.; 11.07.19

TAPING AND REEL DIMENSIONS in millimeters: VSMY2893SLX01

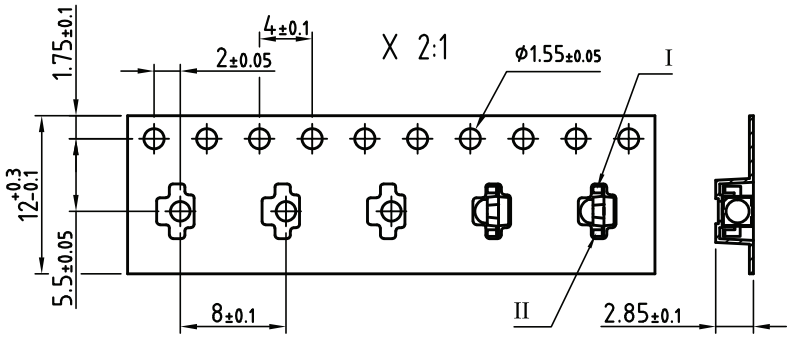


Leader and trailer tape:



Terminal position in tape

Device	Lead I	Lead II
VSMB2943SLX01	Cathode	Anode
VSMF2893SLX01		
VSMB2948SL		
VEMD2023SLX01		
VEMD2523SLX01		
VEMT2023SLX01	Collector	Emitter
VEMT2523SLX01		
VSMY2xxx	Anode	Cathode



Drawing refers to following types: see table
Reel dimensions and tape

Drawing-No.: 9.800-5123.01-4
Issue: preliminary, 11.07.19

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